

Optoelectronic semiconductor component

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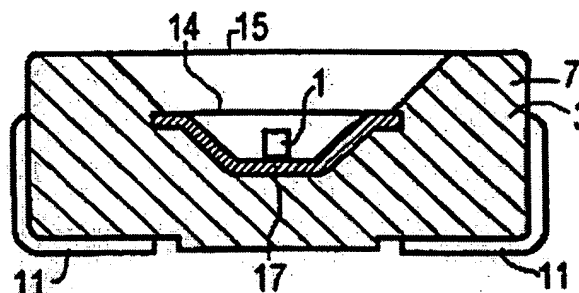
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Abstract of DE19536454

In a radiation-emitting and/or receiving semiconductor component, a radiation-emitting and/or receiving semiconductor chip (1) is secured on a chip carrier (2) in a conductor frame. The chip carrier (2) forms a trough (4) in the area in which the semiconductor chip (1) is secured. The inner surface (5) of the trough (4) is designed to form a reflector for the radiation emitted and/or received by the semiconductor chip (1).



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